

# DATA SHEET

SUNGMUN CODE : GSER-16J  
DESCRIPTION : MINI ROTARY DIP SWITCH

## SUNGMUN ELECTRONICS CO., LTD.

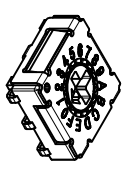
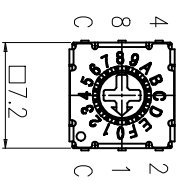
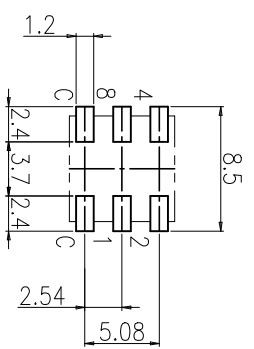
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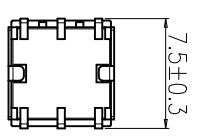
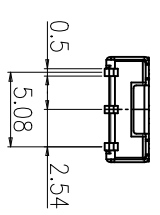
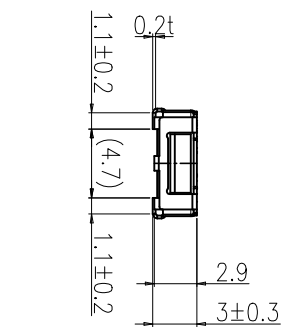
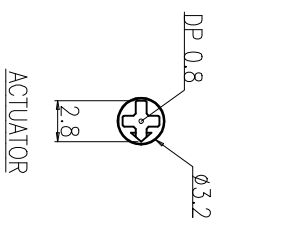
REV. NO.	DATE	REVISION	DR	CH	APP
△	25.05.07	DIN ISO-2768-1m tolerance applied	W.R.KYUNG	K.M.KIM	W.J.LEE

## SPECIFICATION

1. Rating : 100mA, DC 5V (Switching)  
100mA, DC 50V (None-Switching)
2. Contact Resistance : 100mΩ Max
3. Insulation Resistance : 100MΩ Min at DC 100V
4. Operating Force : 200gf cm Max
5. Life cycle : 25,000 steps
6. Sealing : IP67 (Dust & Water proof)



P.C.B DIMENSION (TOP VIEW)



Real Coded								
	C	1	2	4	8			
0	●							0
1	●	●						1
2	●		●					2
3	●			●				3
4	●				●			4
5	●	●						5
6	●		●					6
7	●	●	●					7
8	●				●			8
9	●		●					9
10	●			●				A
11	●	●						B
12	●				●			C
13	●		●					D
14	●			●				E
15	●				●			F

16 Positions

DRAWN/DESIGNED	CHECKED	APPROVED	UNIT	G.TOL	TITLE
H.S LEE	K.N KIM	W.J LEE	mm	3X3	COMPACT ROTARY DIP SWITCH
2022-10-21	2022-10-21	2022-10-21	N:S	MODEL NO.	GSER-16J
DIN ISO-2768-1m			SIZE	DRAW NO.	GSER-16J-02
Ranges	0.5-3	3-6	6-30	30-120	120-400
Tolerance	±0.1	±0.1	±0.2	±0.3	±0.5
SUNGUMUN ELECTRONICS CO.,LTD					REV.
					02

**1. Style:**

This specification describes "Compact Mini Rotary Dip Switch" which is G series.

1.1 Operating / Storage Temperature Range : -40°C ~ +85°C

**2. Rating:**

2.1 None-Switching : 100 mA, DC 50V

2.2 Switching : 100 mA, DC 5V

3. Type of Actuation : Rotating

**4. Electrical Characteristics**

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
4-1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
4-2	Contact Resistance	① To be measured between the two terminals associated with each switch pole. ② Measurements shall be made with a 1kHz shall current contact resistance meter.	100mΩ max. (initial)
4-3	Insulation Resistance	100V DC	100 MΩ min.
4-4	Dielectric withstanding Voltage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame for 1 minute.	There shall be no breakdown or flashover.

## 5. Mechanical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
5-1	Operation Force	Operating direction shall be clockwise or counter clockwise direction	200gf•cm max (1.96N•cm max)
5-2	Operation Life	Measurements shall be made following the test set forth below: 1)100mA, 5V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 10,000 steps	1)As shown in item 3,4 2)Contact Resistance: 200mΩ max 3)Final-after test

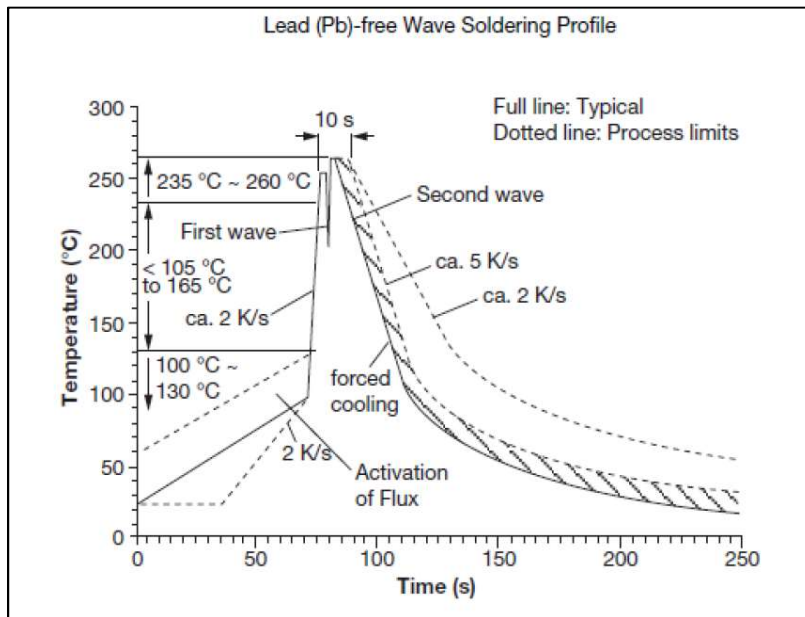
## 6. Environmental Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
6-1	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -40°C ±3°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200mΩ max
6-2	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 85°C ±2°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200mΩ max
6-3	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 40°C ±2°C 2)Relative humidity: 90~95% 3)Time: 240 hours	1)As shown in item 4-4, 5-1 2)Contact Resistance: 200mΩ max 3)Insulation Resistance: 10 MΩ min

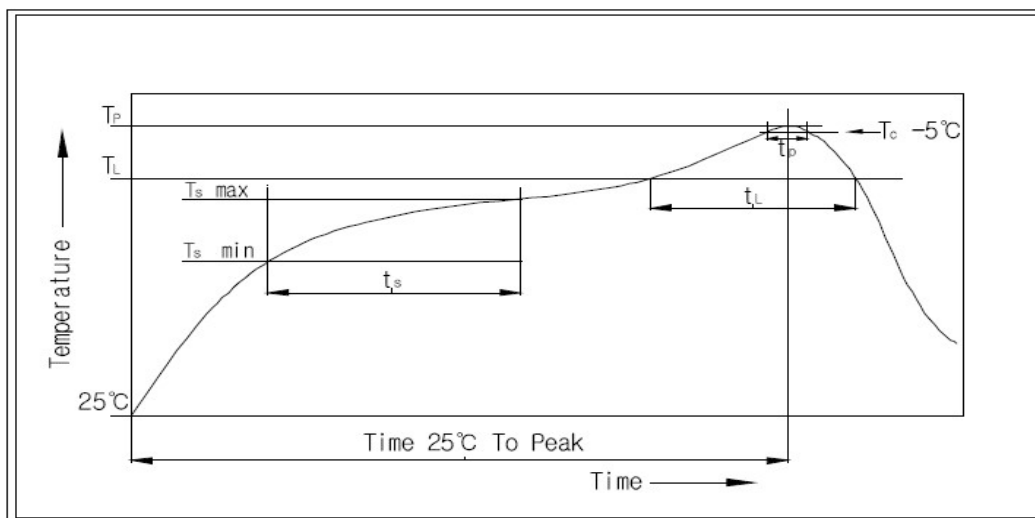
7. This item is "RoHS" Compliant

8. Manual Soldering : Max 350°C, 3 sec.

9. Wave Soldering Conditions:



10. Reflow Soldering Conditions:



**10-1 Condition for Soldering**

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate(Ts max to TP)	3°C/second max
Preheat	
- Temperature Min(Ts min)	150°C
- Temperature Max(Ts max)	200°C
- Time (ts min to ts max)	60-180seconds
Time maintained above:	
- Temperature (TL)	217°C
- Time (tL)	60-150seconds
Peak/Classification Temperature(TP)	260°C +0°C/ -5°C
Time within 5°C of actual Peak Temperature(TP)	5~10 seconds
Ramp-Down Rate	6°C/sec max
Time 25°C to Peak Temperature	8 minutes max